LT-ASIA

LISTECHNOLOGIES ASIA SDN. BHD.



SOLDER/BOT

MELSS, INDIA Robotic Soldering



USB SOLDERING MACHINE |
JIT-SD205H



Solder Paste



Model 203H
Eddy Current Lead Free
Soldering Machine

Model 315D
Lead-free Soldering Station





Flux-Cored wire





Cyberbond
UNDO 6020 Remover



Cyberbond CA

EV Bond 420



Clearnroom Wipes



MC200



Durated 400
Inhibitor 65H
Cimclean HA401D



Cleanroom Mops



N29AUTO



Presaturated
Cleanroom
Mircofiber Wipes



N29HV

ABOUT COMPANY

LISTECHNOLOGIES ASIA

Are an established distribution and representatives for a world-class soldering materials, Electronics Cleaning Machine, Robotics Soldering Machine, Contamination Cleaning, Adhesive Epoxy, and Conformal Coating.

We are incorporated in Malaysia and HQ in Penang.

We are looking into expanding our market in areas of Malaysia and Singapore.

Additionally, we have a well developed supporting industry, capable of meeting the needs of the multinational corporations as well as small and medium industry (SMI).

As a Channel Partner and Strategic Marketing Partner, Listechnologies Asia has built a strong network of logistic and storage support, creating a comprehensive logistics hub for customers across the region.

PENANG – KUALA LUMPUR – JOHOR – SINGAPORE

OUR PRINCIPALS

MBtech

MELSS

INDIUM CORPORATION

Foamtec International

H.B. Fuller

DuBois Sustainable Cleaning Solutions

CIMCOOL FLUID TECHNOLOGY

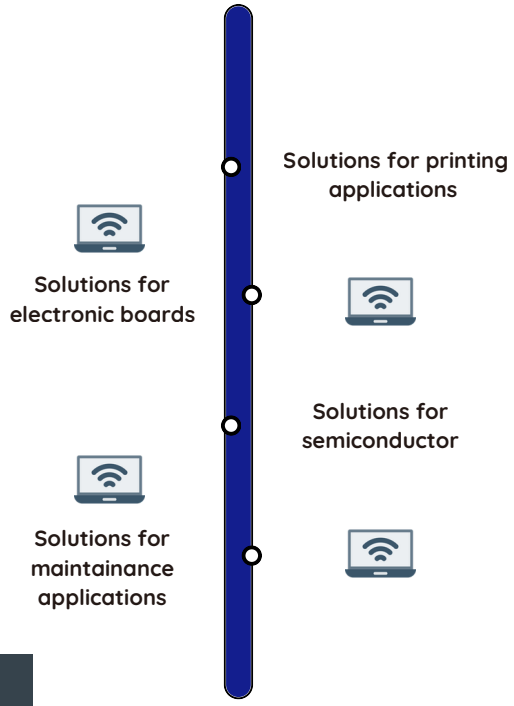
JIT

Your Cleaning Partner

More than only a high precision cleaning machine manufacturer, MBtech is imposing itself as a partner focusing on your needs, providing you dedicated solutions.

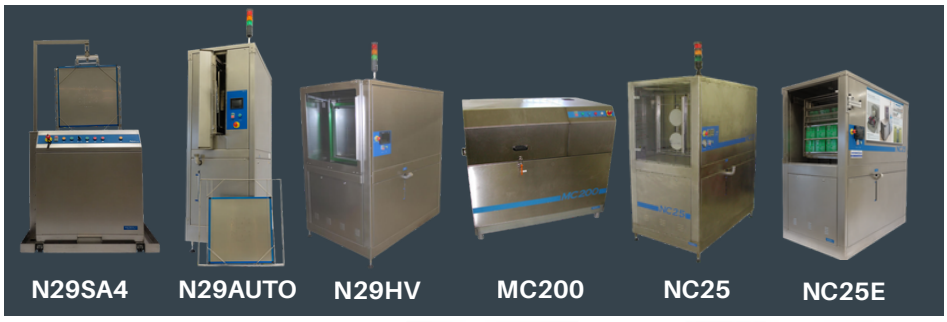
Our equipment enable a high precision cleaning for the lowest running cost on the market. The main reason: MBtech develops a dedicated solutions around the product that needs to be cleaned (stencils, boards, wafers, parts, etc) using patented technologies.

- Our solutions for printing applications
- Our solutions for electronic boards
- Our solutions for semiconductors
- Our solutions for maintenance applications
- Special Applications



The **“3E”** is the main philosophy of all our machines:

- **Efficiency**,
- **Economy**,
- **Environment**.





Printing applications cleaning

Our cleaning systems provide an exceptional cleaning performance for the lowest operation cost on the market.



Electronic boards cleaning

MBtech exploits an exclusive licence of a set of International Patents covering the perfect filtration of water-based cleaning liquids as well as unique cleaning technologies offering best in class results.



Semiconductor cleaning

All our machine are engineered in compliance with our customers' needs.We help you make the right choice for all your cleaning problems.



Maintenance cleaning

Efficient, easy to use and to maintain, while being extremely robust, MBtech systems increase the profitability of your cleaning processes.

MELSS

The MELSS SolderBot simplifies soldering with repeatability and accuracy. The SolderBot can be installed as a standalone table top unit or in an assembly line.

- Up to 15 solders per minute Variable Power
- Programmable Temperature
- Automated programmable wire feeder
- Programmable soldering time
- Wide variety of soldering cartridges
- Integrated with Tip Cleaner
- Real - time process display
- Easy to use software. No complex programming required
- Multiple program storage with cloning option
- Traceability by barcode/ serial number of every part
- Quick point teaching using joystick
- Library of standard components for faster teaching
- Define temperature, solder time, wire feeding parameters per solder



SOLDER/BOT

MELSS, INDIA Robotic Soldering

- 125W/250W Powerful Soldering Engine
- Easy Setup
- Wide Variety of Cartridges option for Point/ Drag Soldering



Indium Corporation ®

INTRODUCTION

Indium Corporation is a premier materials refiner, smelter, manufacturer, and supplier to the global electronics, semiconductor, thin-film, and thermal management markets.

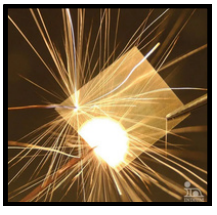
Founded in 1934, the company has global technical support and factories located in China, Germany, India, Malaysia, Singapore, South Korea, the United Kingdom, and the U.S.

OUR PRODUCTS

Products include solder paste and fluxes; brazes; thermal interface materials; sputtering targets; indium, gallium, germanium, and tin metals and inorganic compounds; and Durafuse® (HIGH REL MATERIALS).

- Increase Yields
- Improve Customer Satisfactions
- Reduce Defects
- Increase Revenue

Indium scientists, applications engineers, and technical support engineers work closely with our customer to develop custom solutions to their technical problems and optimize their processes to:



NanoFoil®



Wave Flux



Flux-Cored wire



Solder Paste



Flux-Coated Preforms

OUR PRODUCTS

DuraTEC 400

Ambient Temperature Phosphate-Free Pretreatment

Description

DuraTEC 400 is the easiest to use phosphate-free pretreatment product available. It will provide superior paint adhesion and corrosion resistance to mild steel, galvanized steel, and aluminum substrates. DuraTEC 400 offers the potential for savings based on its long bath lives as well as its low operating temperatures.

Product	Working Temp	ECoat Friendly	Description
DuraTEC 400	80 - 115°F	NO	An easy-to-use pretreatment, providing faster and more complete heavy coating formation on ferrous and nonferrous metals.

CIMCLEAN® HA401D

Description

CIMCLEAN HA401D is a heavy-duty cleaner for ferrous and non-ferrous metals.

Application

CIMCLEAN HA401D is intended primarily for use in large multiple stage tunnel washers, cleaning aluminum and ferrous parts or sheet stock. It is also excellent in cleaning off soils such as metal forming lubricants, coolants and corrosion inhibitors.

Rust Inhibitor 56H

Description

Rust Inhibitor 56H will passivates steel surfaces with selected corrosion inhibitors, protecting parts from rust after drying. It is ideal as a final dip after plating, cleaning, pickling, phosphating tumbling, wet grinding, or general machine shop processes. The formula contains no nitrites and provides extremely fast drying, as its inhibitors reduce surface tension and allow water to shed instantly. It leaves an invisible, dry, non-oily film that prevents corrosion without altering the metal's appearance, ensuring surfaces retain their original luster and brightness.

KEY PROPERTIES

- Next Generation Phosphate-Free Technology
- Easy-to-Use
- Most forgiving pretreatment against flash rust
- Easy-to-See Coating
- Faster & More Complete Heavy Coating Formation
- NITRIC ACID-FREE
- Low operating temperature of ambient to 115° F
- Provides paint adhesion and corrosion resistance exceeding iron phosphates
- Effective on ferrous and nonferrous metals
- Produces minimal sludge and provides a long bath life
- Best adhesion results of non-phosphate pretreatments

- **DURATEC 400,**
- **INHIBITOR 65H,**
- **CIMCLEAN HA401D**



H.B. Fuller



Advanced Adhesive Solutions for the Electronics Industry

H.B. Fuller provides high performance electronics adhesives and sealants that helps manufactures design, assembles, and protect today's most advanced electronics devices. As electronics become smaller, smarter, and more integrated, manufacturers need materials that deliver precision, durability, and long term reliability. Our solutions are engineered to meet those demands across a wide range of electronics markets and applications.

With global formulation expertise and local technical support, H.B. Fuller partners with electronics manufacturers to improve product performance, streamline production and suport innovation across the full electronics lifecycle.

Electonics Adhesives Solutions for the Electronics Industry

Our electronics adhesive and sealant technologies are designed to support critical manufacturing and performance requirements, including:

- Structural bonding and component attachment
- Sealing and environmental protection
- Electrical insulation and circuit protection
- Thermal management and heat dissipation
- Vibration damping and shock resistance

These solutions help protect sensitives electonics components while enabling efficient, scable manufacturing processes - from high volume consumer products to mission critical system.

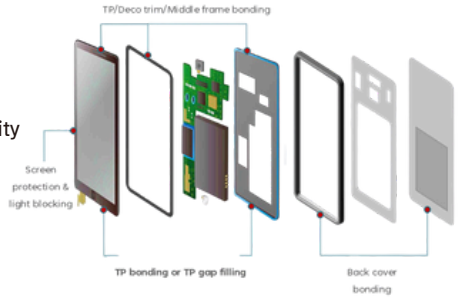


OUR PRODUCTS

RHM (Reactive Hot Melt)	**EH9303** Structure Bonding High Reliability	**EH9317** Structure bonding Fast Fixture	**EH9520** Structure Bonding Chemical Resistance	**AE3202** Structure Bonding Automotive	
LTCA (Low Temperature Curing Adhesive)	**FH8634** Structure Bonding (Speaker Magnet Bonding) Fast Curing	**FH8644** Structure Bonding (Speaker Magnet Bonding) Low Shrinkage			
2K	**FH8516** Structure bonding 2K Epoxy General purpose	**FH7013LV** Structure bonding 2K MMA General purpose			
UV/M (UV Moisture Dual Curing)	**EA6155** Structure Bonding High Adhesion	**EA6181** Structure Bonding High Thixotropic	**EA6137** Structure Bonding UV Delay		
UV/HT (UV Heat Dual Curing)	**EA6430** Board Level Component Encap.	**EA6416** Structure Bonding Fast UV Fixture	**AD2109** Structure Bonding Auto Camera		
Epoxy	**FH8019** Board Level Underfill – Consumer	**FH8321** Board Level Underfill – Automotive	**FH8709T** Board Level Edge Bond	**FH8746** Board Level Component encap.	**FH8733L** Board Level COB (Chip On Board)

MARKET REQUIREMENTS FOR STRUCTURE BONDING

- Substrates to be bonded: Ink glass, plastic (PC, PBT, PA), metal (An, Al, SUS)
- Jet dispensing
- Short clamping time
- Adhesion & Impact resistance
- **High Environmental Resistance:**
  > Hot strength
  > Creep resistance under heat & humidity
- Chemical resistance
- **Reworkable:**
  > Debond
  > Peel ability



ADHESIVE APPLICATION



WEARABLE DEVICE

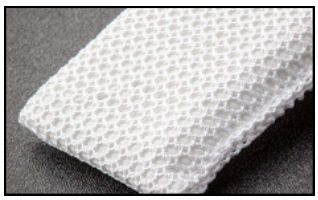


LAPTOP/TABLETS

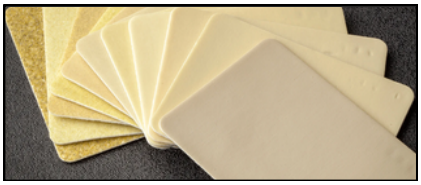
Foamtec International

OUR PRODUCTS

Cleaning Sponges



Vaccum Chamber Cleaning Products



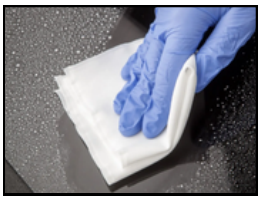
Presaturated Cleanroom Mircofiber Wipes



Cleanroom Accessories



Clearnroom Wipes



Cleanroom Mops



Cleanroom Swabs



ABOUT US

The Wilshire Contamination Control Division of Foamtec International supplies clean room mops, foam swabs, microfiber swabs, foam wipers, microfiber wipers, UltraSOLV® ScrubPADS to address clean room cleaning and the critical cleaning of process equipment.

MISSION

Foamtec's mission is to enable contamination control professionals to improve particle control in clean rooms by solving surface contamination challenges.

KEY PROPERTIES

Protection
The foam sponge interior offers excellent protection for sensitive surfaces and prevents scratches, extending the lifespan of the equipment and maintaining its optimal performance.

Efficiency
The robust cleaning capabilities of the cleanroom foam sponges reduce the time and effort required to clean equipment, ensuring that it is ready for use quickly and efficiently.

Cleanliness
Non-shedding foam reduces particle shedding during cleaning, ensuring a high level of cleanliness and minimizing the risk of contamination in critical environments such as cleanrooms. This level of cleanliness also helps to maintain the quality of the equipment and the products it is used to manufacture.

OUR PRODUCTS

High Precision Visual Dispensing Machine ES705



Inline High-Accuracy PCB Conformal Coating



5-Axis Automatic Soldering Machine 5331R



N300 SMT Line Lead-free Wave Soldering Machine



Model 203H Eddy Current Lead Free Soldering Machine



Model 315D Lead-free Soldering Station



Model 989D Constant Temperature Soldering Station





USB SOLDERING MACHINE | JIT-SD205H

This product is designed for multi-wire soldering applications including switches, resistors, terminals, connectors, LED lights, diodes, transistors, aluminum PCB boards, DB9/DB25 connectors, DC plugs, audio connectors, aviation connectors, waterproof connectors, USB connectors, microphones, springs, coils, speakers, motors, potentiometers, sensors, circuit boards, and wiring harnesses.

It is a practical and versatile soldering solution featuring multiple soldering modes, high efficiency, pre-tin capability, easy operation, and low skill requirement.



Vacuum Packaging Machine

Sealing Strip Length	520MM
Sealing Strip Width	8MM
Sealing Time	0–6S
Vacuum Time	0–99S
Inflation Time	0–99S
Cooling Time	0–9S
Ultimate Vacuum	≤1.332KP
Working Table Size	550 × 300MM
Motor Power	1000W
Voltage	220V 50Hz
Machine Weight	41KG
Machine Dimensions	660 × 660 × 410MM

Machine Specification

Item	Specification
Power	MAX <20W
Input Voltage	200-240V / 50HZ output 24V/2A
Welding Mode	Set according to working mode
Operating Ambient Temperature	0-40°
Operating Environment Humidity	0-70%
Equipment Materials	Aluminium alloy
Overall Size	L320 * W240 * H300
Weight (excluding packaging)	Approximately 5.5kg



OUR SERVICE

- Tech Support
- Channel Partner
- Product Distribution
- Marketing & Sales Coordination
- Warehousing
- Reliable Sourcing & Supply Support
- Repackaging Capabilities
- Customer Service & Client Management
- Local Storage & Logistics Support
- Regional Logistics Hub Capabilities

WHY US?

- Experts in solder paste & flux logistics
- Trusted partnership with leading brands
- Precision packaging for sensitive materials
- Reliable, and environment controlled delivery
- Proven quality and customer support

OUR ACHIEVEMENT

LISTECHNOLOGIES ASIA has grown into a trusted regional leader in advanced electronic materials, including pretreatment chemicals and SMT/SEMICONDUCTOR cleaning machines solutions.

One of **Our Key Early Milestones** was being appointed as a Representative and Channel Partner for Indium Corporation® following our incorporation as a Private Limited company.

To support our growing customer base, we established full logistics and storage facilities in Penang and Johor, and expanded our Johor operations to strengthen sales and distribution performance.

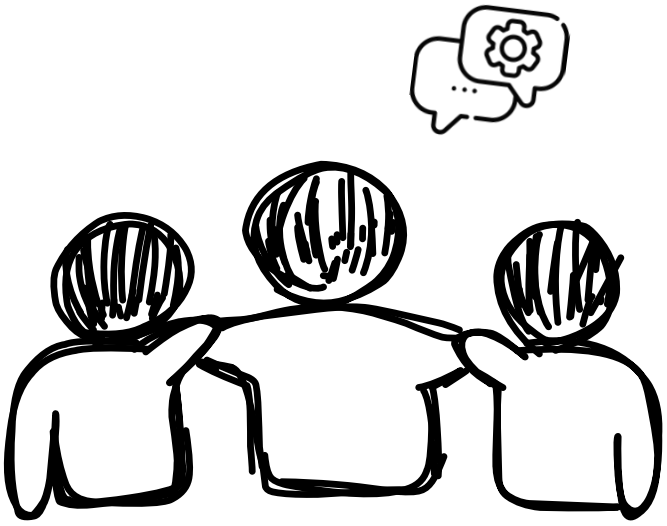
Our Global Partnerships have continued to expand, including appointments as the sole authorized representative for MB Tech (France), a Channel Partner for FOAMTEC Inc., an authorized Distributor for HB Fuller – Electronic Division.

Our Dedication to Excellence has been recognized through multiple SMTA honors, including international leadership awards, the SMTA Founder's Award (Penang Chapter), and recognition during the SMTA Penang Vendor & Technical Day.

We also successfully fulfilled the Micron Global Supply Chain Compliance requirements, demonstrating our strong commitment to world-class standards.

Our branding as **LISTECHNOLOGIES ASIA** marks the next step in our journey, strengthening our market reach and elevating our service capabilities across the Asia market.





Need Assistance?

Our team is always ready to assist in any way we can!

GET IN TOUCH

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